

## Declaration of Non-use of Banned Substances

It is the policy of Plessey Semiconductors Limited, that all purchased materials shall satisfy current EU legislative requirements and health and safety constraints on restricted toxic and hazardous materials.

### Restriction of Hazardous Substances – RoHS

Plessey Semiconductors Limited confirms that all products supplied to its customers do not exceed the allowable limits for the following substances:

Lead	0.1% by mass
Mercury	0.1% by mass
Cadmium	0.01% by mass
Hexavalent Chromium	0.1% by mass
Polybrominated Biphenyls – PBB	0.1% by mass
Polybrominated Diphenyl Ethers – PBDE	0.1% by mass
Bis (2-Ethylhexyl) phthalate – DEHP	0.1% by mass
Benzyl butyl phthalate – BBP	0.1% by mass
Dibutyl phthalate – DBP	0.1% by mass
Diisobutyl phthalate – DIBP	0.1% by mass

As defined in EU Directive 2011/65/EC (RoHS2) and EU Directive 2015/863 (RoHS3)

### Registration, Evaluation, Authorisation and Restriction of Chemicals – REACH

All wafers and packaged products supplied by Plessey are classified as articles and therefore do not need to be registered under REACH.

Plessey confirms that all wafers and packaged products supplied to its customers, do not contain any of the 197 substances included on the candidate list of substances of very high concern (SVHC list) as it stands updated on 15<sup>th</sup> January 2019. Plessey products do not contain any of the substances listed in Annex XVII of the REACH Regulations.



Chief Operating Officer

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